

December 2014

FDPF041N06BL1 N-Channel PowerTrench[®] MOSFET 60 V, 77 A, 4.1 mΩ

Features

- $R_{DS(on)}$ = 3.5 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 77 A
- Low FOM R_{DS(on)}*Q_G
- Low Reverse Recovery Charge, Q_{rr}
- Soft Reverse Recovery Body Diode
- Enables Highly Efficiency in Synchronous Rectification
- Fast Switching Speed
- 100% UIL Tested
- RoHS Compliant

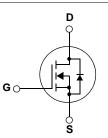
Description

This N-Channel MOSFET is produced using Fairchild Semiconductor[®]'s advanced PowerTrench[®] process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- Synchronous Rectification for ATX / Server / Telecom PSU
- Battery Protection Circuit
- Motor Drives and Uninterruptible Power Supplies
- Renewable System





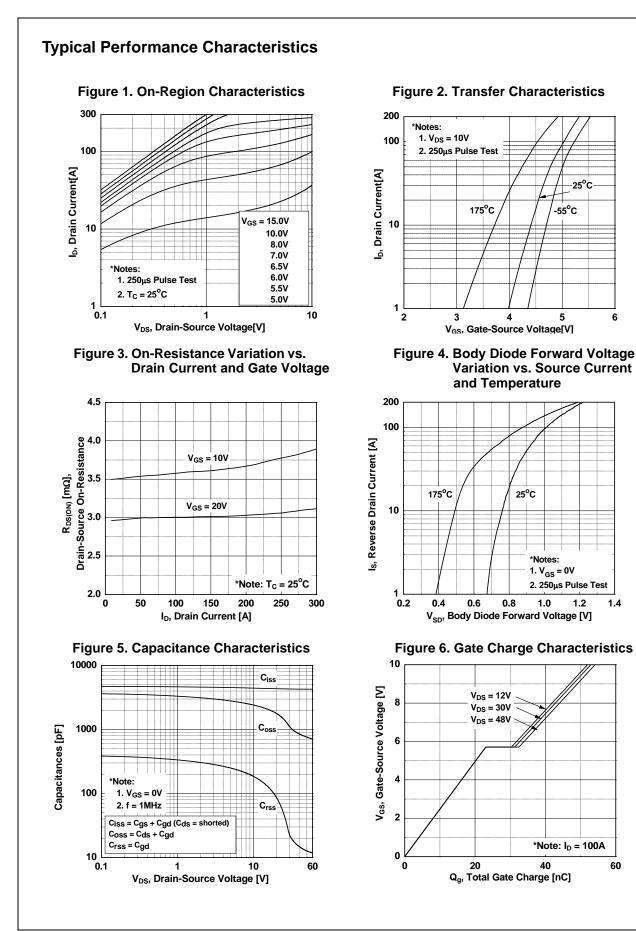
MOSFET Maximum Ratings T_C = 25°C unless otherwise noted*

Symbol		FDPF041N06BL1	Unit	
V _{DSS}	Drain to Source Voltage		60	V
V _{GSS}	Gate to Source Voltage		±20	V
ID	Drain Current	- Continuous (T _C = 25 ^o C, Silicon Limited) 77	- A
	Drain Current	- Continuous (T _C = 100°C, Silicon Limite	d) 55	
I _{DM}	Drain Current	- Pulsed (Not	e 1) 308	А
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		e 2) 365	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		e 3) 6.0	V/ns
P _D	Dower Discinction	$(T_{\rm C} = 25^{\rm o}{\rm C})$	44.1	W
	Power Dissipation	- Derate above 25°C	0.29	W/ºC
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +175	°C
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds		300	°C

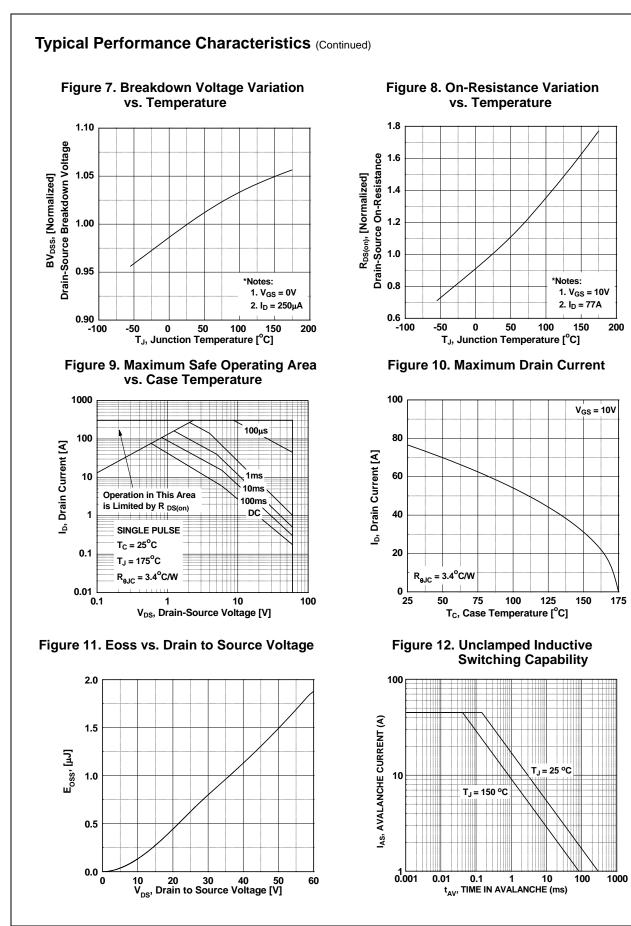
Thermal Characteristics

Symbol	Parameter	FDPF041N06BL1	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max	3.4	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max	62.5	°C/vv

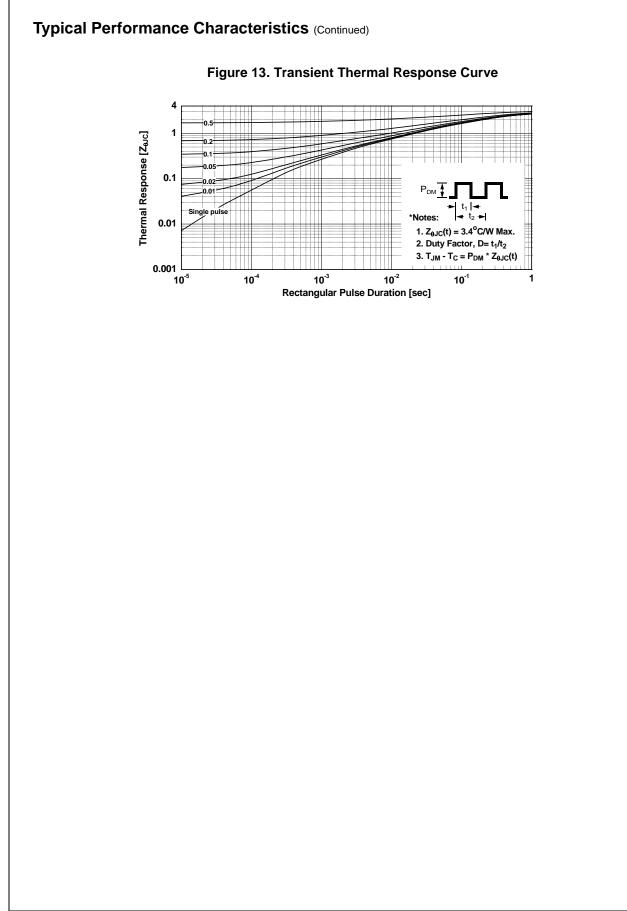
	e Marking	Device	Package	Pack	aging T	уре	Qua	ntity
FDPF041N06BL1 FDPF041N06BL1			TO-220F		Tube		50	
Electrica	I Character	ristics T _C = 25°C unless	s otherwise noted					
Symbol		Parameter	Test Conditions		Min.	Тур.	Max.	Unit
Off Charac	teristics							
BV _{DSS}	Drain to Source	e Breakdown Voltage	I _D = 250μA, V _{GS} = 0V		60	-	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient		$I_D = 250\mu$ A, Referenced to 25° C		-	0.03	-	V/ºC
I _{DSS}	Zero Gate Volta	age Drain Current	$V_{DS} = 48V, V_{GS} = 0V$		-	-	1	μA
I _{GSS}	Gate to Body L	eakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$		-	-	±100	nA
On Charac	teristics					l.	1	1
V _{GS(th)}	Gate Threshold	d Voltage	V _{GS} = V _{DS} , I _D = 250μA		2	-	4	V
R _{DS(on)}		Source On Resistance	$V_{GS} = 10V, I_D = 77A$		-	3.5	4.1	mΩ
9 _{FS}	Forward Transo	conductance	V _{DS} = 10V, I _D = 77A		-	125	-	S
	haracteristic	S						
C _{iss}	Input Capacitar				-	4280	5690	pF
C _{oss}	Output Capacita		$V_{DS} = 30V, V_{GS} = 0V$		-	1050	1400	pF
C _{rss}	Reverse Transf		f = 1MHz	_	-	23	-	pF
C _{oss(er)}		Output Capacitance	V _{DS} = 30V, V _{GS} = 0V		-	1787	-	pF
Q _{g(tot)}	Total Gate Cha		$V_{DS} = 30V, I_D = 100A$		-	53	69	nC
Q _{gs}	Gate to Source	-			-	23	-	nC
Q _{gd}	Gate to Drain "I		V _{GS} = 10V		-	8	-	nC
V _{plateau}	Gate Plateau V	olatge	(Note 4)	-	5.7	-	V
Q _{sync}	Total Gate Cha	rge Sync.	$V_{DS} = 0V, I_{D} = 50A$ (Note 5)	-	48.6	-	nC
Q _{oss}	Output Charge		$V_{DS} = 30V, V_{GS} = 0V$		-	63.8	-	nC
Switching	Characteristi	cs						
	Turn-On Delay				-	29	68	ns
t _{d(on)} t _r	Turn-On Rise T		V _{DD} = 30V, I _D = 100A		-	20	54	ns
t _{d(off)}	Turn-Off Delay		$V_{GS} = 10V, R_{GEN} = 4.7\Omega$		-	38	86	ns
t _f	Turn-Off Fall Tir			Note 4)	-	11	32	ns
ESR	Equivalent Seri	es Resistance (G-S)	f = 1MHz	,	-	0.8	-	Ω
Drain-Sou	1					I		
	urce Diode Characteristics Maximum Continuous Drain to Source Diode Forward Current - - -				_	77	A	
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current				-	-	308	A
V _{SD}		Diode Forward Voltage	$V_{GS} = 0V, I_{SD} = 77A$		-	-	1.25	V
-	Reverse Recov	ery Time	V _{GS} = 0V, I _{SD} = 100A		-	65	-	ns
t _{rr}	D	ery Charge	$dI_{F}/dt = 100A/\mu s$		-	63	-	nC

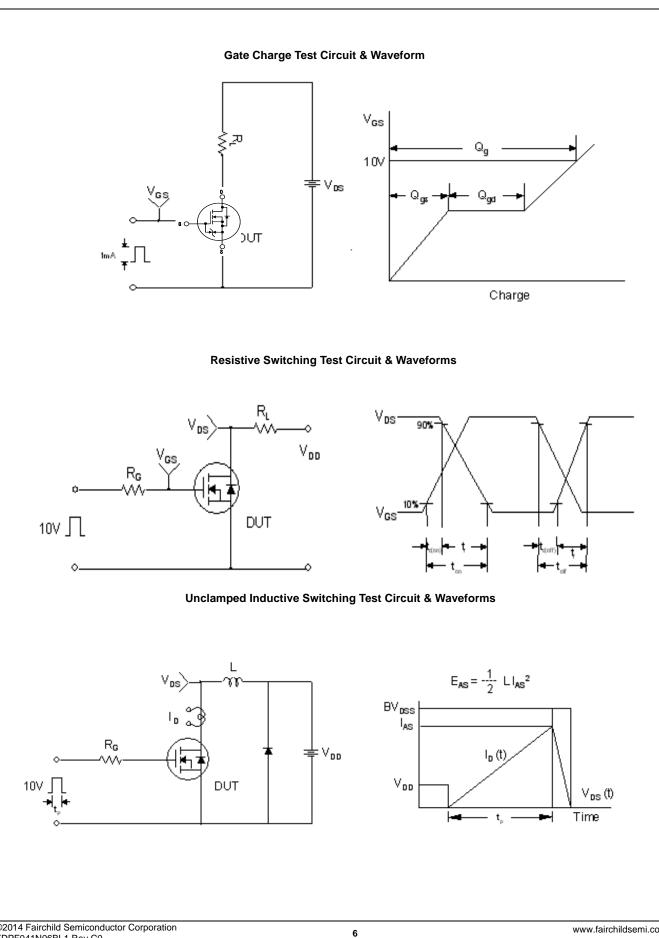


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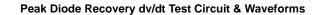
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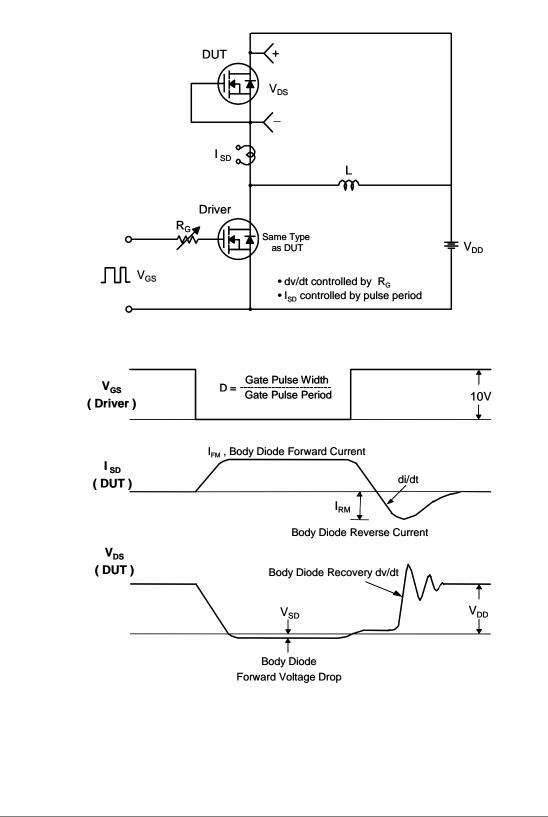




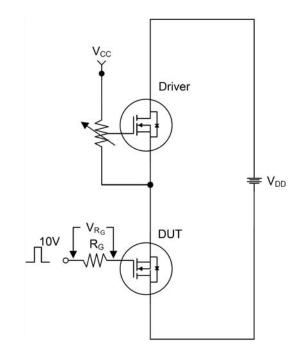
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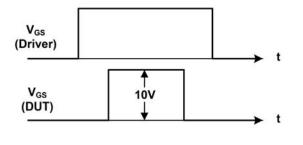
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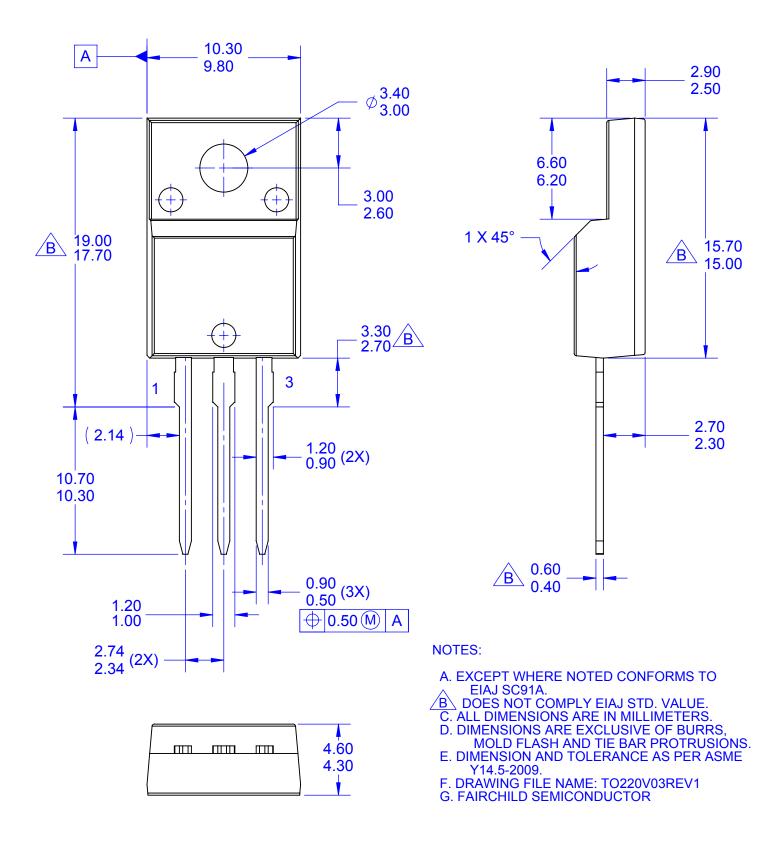


Total Gate Charge Qsync. Test Circuit & Waveforms





$$Qsync = \frac{1}{R_G} \cdot \int V_{R_G}(t) dt$$





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Rev. 177